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Fixed Ceramic Capac	citors					
	R1A106M/1.25					
Product Name :	(TAT00W/1.23					
Multilayer Ceramic Chip Ca	pacitors - Ge	neral Purpose	_			
View Datasheet						
TDK Series Name : CS	eries					
Application :						
Electronics equipment, Mobile communications equipment, Office automation equipment, Automotive electronics, Test and measurement equipment, Hybrid ICs, Decoupling, Smoothing, Charge pump, etc.						
Function :						
t has no polarity. High relia or various circuit such as hrough.						
Description :						
Small Size High Capacitano nas no polarity. High reliab		ic Chip Capacitor. It		< Prev No PDF Available	Next >	
Submit Sample Request						
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Application	Catalog	SEAT	CCV	TVCL	Tech Notes	
Drop	erty Name			Property Description		
Prop Product Lifecycle Stage	ony name	Production				
Product Lifecycle Stage Part Number Replacement		No Data Availab	le			
Lead (Pb) Free		Yes				
Surface Mount		Yes				
EIA Size Code		0805				
Size Code		2012				
		2012 Min 1.8 mm				
Body Length (L)		Nom 2 mm				
Body Length (L)						
Body Length (L)		Max 2.2 mm Min 1.05 mm				
Body Breadth (W)		Nom 1.25 mm				
Body Breadth (W)		Max 1.45 mm				
Body Breadth (W) Body Height (T)		Min 1.05 mm				
		Nom 1.25 mm				
Body Height (T)		Max 1.45 mm				
Body Height (T) Terminal Width (B)		Min 0.2 mm				
Terminal Spacing (G)		Min 0.2 mm				
Temperature Characteristics		X5R				
Temperature Characteristic		Min -15 %				
		Max 15 %				
Category Temperature Rang	le	Min -55 C				
	,0	Max 85 C				
Rated Voltage Code		1A				
Rated Voltage		Max 10 V				
Rated Voltage Classification		DC				
Withstanding Voltage		Nom 25 V				
Withstanding Voltage Class		DC				
Rated Capacitance		Nom 1000000	pF			
Capacitance Tolerance Code	9	M	Ч			
Capacitance Tolerance (Valu		Min No Data Av	ailahle			
)	Max No Data A				
Capacitance Tolerance (%)		Min - 20 %				
,		Max 20 %				
Q		Min No Data Av	ailable			
✓ Measurement Frequency of	Q	Nom No Data A		9.		
Insulation Resistance		Min 10 MOhm				
Dissipation Factor		Max No Data A	vailable	9.		
Frequency of Dissipation Fa	ctor	Nom 1 kHz				
Soldering Method		Flow, Reflow, N	lanual			
Storage Temperature Range)	Min 5 Cel				
		Max 40 Cel				
Packing		Blister (Plastic)	Taping	[180mm Reel]		
Minimum Package Qty		Nom 2000 Pc		_ ••••		
Minimum Order Qty		Nom 2000 Pc				
Return Status		STD	-			
reflects an overview of the pro information, please refer to TD warranted to meet any specific in TDK's general product spec	duct character K's general product spe ations of any intermedi	ate or end user different from or in ac this standard part has not been spec	art numb te that the that the that the theta the	ber. For product specification his standard part is not designed or to the specifica igned or manufactured for,	tions set fort	